

Vishay High Power Products

FlipKY®, 1 A



 $\mathsf{FlipKY}^{ exttt{@}}$

PRODUCT SUMMARY			
I _{F(AV)} 1 A			
V_{R}	30 V		

FEATURES

- Ultralow V_F per footprint area
- · Low thermal resistance
- · One-fifth footprint of SMA
- Super low profile (< 0.7 mm)
- · Available tested on tape and reel
- · Small footprint, surface mountable
- · Low forward voltage drop
- · High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Designed for consumer level

DESCRIPTION

True chip-scale packaging is available from Vishay HPP. The FCSP130ETR surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small footprints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

The FlipKY® package, is one-fifth the footprint of a comparable SMA package and has a profile of less then 0.7 mm. Combined with the low thermal resistance of the die level device, this makes the FlipKY the best device for applications where printed circuit board space is at a premium and in extremely thin application environments such as battery packs, cell phones and PCMCIA cards.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	1.0	Α			
V _{RRM}		30	V			
I _{FSM}	t _p = 5 μs sine	220	Α			
V _F	1.0 Apk, T _J = 125 °C	0.33	V			
T _J	Range	- 55 to 150	°C			

VOLTAGE RATINGS				
PARAMETER	SYMBOL	FCSP130ETR	UNITS	
Maximum DC reverse voltage	V_{R}	30	V	
Maximum working peak reverse voltage	V_{RWM}	30	V	

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ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T _{PCB} = 120 °C, rectangular waveform		1.0	
Maximum peak one cycle		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	220	Α
non-repetitive surge current at 25 °C	I _{FSM}	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	21	
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, \ I_{AS} = 2.0 \text{A}, \ L = 5.0 \text{mH}$		10	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _B typical		2.0	А

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Maximum forward voltage drop V _{FM}		1 A	- T _J = 25 °C	0.41	0.45	V
	V (1)	2 A		0.46	0.50	
	V FM ('')	1 A	- T _J = 125 °C	0.29	0.33	
		2 A		0.37	0.40	
Maximum reverse leakage current	I _{RM} ⁽¹⁾	$V_{\rm B} = {\rm Rated} \ {\rm V_{\rm B}}$	T _J = 25 °C	30	100	μΑ
Maximum reverse leakage current	IRM () VR = nateu VR	T _J = 125 °C	10	30	mA	
Maximum junction capacitance	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		-	210	pF
Maximum voltage rate of charge	dV/dt	Rated V _R - 10 000		V/μs		

Note

 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C
Typical thermal resistance, junction to PCB	R _{thJL} ⁽²⁾	DC operation	40	°C/W
Maximum thermal resistance, junction to ambient	R _{thJA}		62	C/VV

Notes

- $\frac{\text{dP}_{tot}}{\text{dT}_J} < \frac{1}{R_{thJA}} \quad \text{thermal runaway condition for a diode on its own heatsink}$
- (2) Mounted on 1" square PCB



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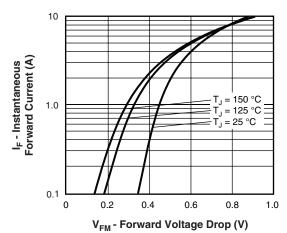


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

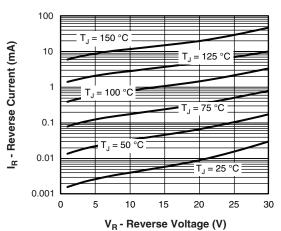


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

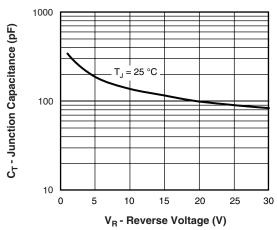
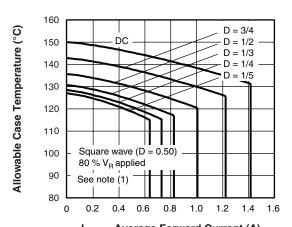


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)



I_{F(AV)} - Average Forward Current (A)

Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

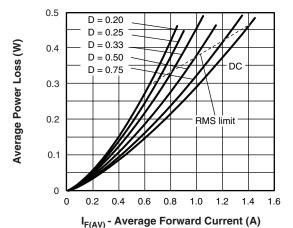


Fig. 5 - Forward Power Loss Characteristics (Per Leg)

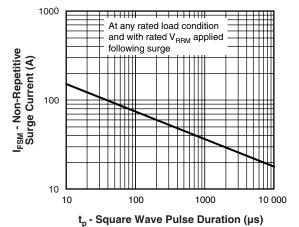


Fig. 6 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = Inverse$ power loss = $V_{R1} \times I_R$ (1 - D); I_R at 80 % V_R applied

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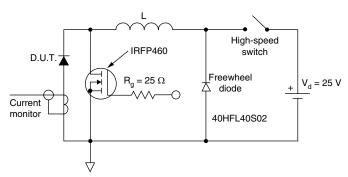


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95359				
Part marking information	http://www.vishay.com/doc?95281			
Packaging information	http://www.vishay.com/doc?95062			



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